Acknowledgements

Intel, Itanium, Pentium, Intel Inside, and the Intel Inside logo are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

Microsoft, Windows, Windows XP, and Windows NT are U.S. registered trademarks of Microsoft Corporation.

Adobe and Acrobat are trademarks of Adobe Systems Incorporated.

Java is a US trademark of Sun Microsystems, Inc.

Oracle is a registered US trademark of Oracle Corporation, Redwood City, California.

UNIX is a registered trademark of The Open Group.

Warranty

WARRANTY STATEMENT: To obtain a copy of the warranty for this product, see the warranty information website:

# Table of Contents

1 Installing the server blade into the enclosure.................................................................7
   Overview..............................................................................................................................7
   Server blade overview.......................................................................................................7
   Server blade dimensions and weight................................................................................7
   Server blade components...................................................................................................8
   SAS disk drives..................................................................................................................8
   SAS disk backplane..........................................................................................................9
   I/O subsystem.....................................................................................................................9
   Partner blade support........................................................................................................9
   Memory subsystem............................................................................................................9
   DIMMs...............................................................................................................................9
   Power subsystem.............................................................................................................10
   Processor and supporting chipset....................................................................................10
   ICH mezzanine card.........................................................................................................10
   Scaleable BladeLink.........................................................................................................10
   Enclosure information......................................................................................................10
   Controls, ports, and LEDs...............................................................................................11
   Front panel view...............................................................................................................11
      Front panel LEDs.....................................................................................................12
      SAS disk drive LEDs...............................................................................................13
      Scaleable BladeLink LEDs.....................................................................................15
      SUV Cable and Ports...............................................................................................16
   Rear panel view...............................................................................................................16
   Safety information............................................................................................................17
   Installation sequence and checklist................................................................................17
   Unpacking and inspecting the server blade.................................................................17
      Verify site preparation..............................................................................................17
      Inspect the shipping containers for damage.........................................................18
      Unpack the server blade.........................................................................................18
      Check the inventory.................................................................................................18
      Damaged equipment returns...................................................................................18
   Installing additional components................................................................................18
   Installing a hot-plug SAS disk drive.............................................................................19
   Installing internal components.....................................................................................20
      Removing the access panel.....................................................................................20
      Installing a processor and heatsink module.........................................................21
      Installing DIMMs...................................................................................................26
      Installing mezzanine cards.....................................................................................30
      Replacing the access panel....................................................................................31
   Installing and powering on the server blade............................................................32
      Preparing the enclosure...........................................................................................32
      Removing a c7000 device bay divider..................................................................33
      Removing a c3000 device bay mini-divider or device bay divider......................34
      Installing interconnect modules..........................................................................35
         Interconnect bay numbering and device mapping........................................36
      Installing the server blade into the enclosure....................................................37
      Installing the Scaleable BladeLink.......................................................................39
   Server blade power states............................................................................................41
   Powering on the server blade......................................................................................41
   Powering off the server blade.....................................................................................41
   Using iLO......................................................................................................................41
<table>
<thead>
<tr>
<th>Section</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>Accessing UEFI or the OS from iLO MP</td>
<td>42</td>
</tr>
<tr>
<td>UEFI Front Page</td>
<td>42</td>
</tr>
<tr>
<td>Saving UEFI configuration settings</td>
<td>44</td>
</tr>
<tr>
<td>Booting and installing the operating system</td>
<td>44</td>
</tr>
<tr>
<td>Operating system is loaded onto the server blade</td>
<td>44</td>
</tr>
<tr>
<td>Operating system is not loaded onto the server blade</td>
<td>44</td>
</tr>
<tr>
<td>OS login prompt</td>
<td>44</td>
</tr>
<tr>
<td>Installing the latest firmware using HP Smart Update Manager</td>
<td>45</td>
</tr>
</tbody>
</table>

2 Support and other resources.................................................................. 47

- Contacting HP                                                             47
  - Before you contact HP                                                 47
  - HP contact information                                                 47
  - Subscription service                                                   47
  - Documentation feedback                                                47
- Typographic conventions                                                 47

Standard terms, abbreviations, and acronyms........................................... 49

Index........................................................................................................... 51
List of Tables

1-1 DIMM pair load order...................................................................................................................27
1-2 DIMM quad load order.................................................................................................................28
1-3 Power States...................................................................................................................................41
1 Installing the server blade into the enclosure

Overview

The HP Integrity BL860c i2 Server Blade is a dense, low-cost, Intel® Itanium® processor server blade. Using a Scaleable Blade Link hardware assembly, multiple BL860c i2 Server Blades can be conjoined to create dual-blade four socket and quad-blade eight socket variants.

<table>
<thead>
<tr>
<th>Name</th>
<th>Number of Conjoined Server Blades</th>
<th>Number of CPU Sockets</th>
</tr>
</thead>
<tbody>
<tr>
<td>BL860c i2</td>
<td>1</td>
<td>2</td>
</tr>
<tr>
<td>BL870c i2</td>
<td>2</td>
<td>4</td>
</tr>
<tr>
<td>BL890c i2</td>
<td>4</td>
<td>8</td>
</tr>
</tbody>
</table>

The three blade configurations support the HP-UX operating system and are designed for deployment in c-Class enclosures, specifically the 10U c7000 and the 6U c3000 Enclosures.

**NOTE:** For purposes of this guide, make sure that the c-Class server blade enclosure is powered on and running properly and that the OA iLO is operational.

Server blade overview

<table>
<thead>
<tr>
<th>Product</th>
<th>CPU cores (quad)</th>
<th>DIMM slots</th>
<th>max memory</th>
<th>PCIe I/O Mezzanine card capacity</th>
<th>SAS Hard Disk Drives</th>
</tr>
</thead>
<tbody>
<tr>
<td>BL860c i2</td>
<td>8</td>
<td>24</td>
<td>192GB with 8GB DIMMs</td>
<td>3</td>
<td>2</td>
</tr>
<tr>
<td>BL870c i2</td>
<td>16</td>
<td>48</td>
<td>384GB with 8GB DIMMS</td>
<td>6</td>
<td>4</td>
</tr>
<tr>
<td>BL890c i2</td>
<td>32</td>
<td>96</td>
<td>768GB with 8GB DIMMS</td>
<td>12</td>
<td>8</td>
</tr>
</tbody>
</table>

Server blade dimensions and weight

**NOTE:** These specifications are for the BL860c i2 Server Blade.

<table>
<thead>
<tr>
<th>Dimensions</th>
<th>value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Height</td>
<td>36.63 cm (14.42 in.)</td>
</tr>
<tr>
<td>Width</td>
<td>5.14 cm (2.025 in.)</td>
</tr>
<tr>
<td>Depth</td>
<td>48.51 cm (19.1 in.)</td>
</tr>
<tr>
<td>Weight</td>
<td>Unloaded: 8.6 kg (19 lb) Fully loaded: 11.3 kg (25 lb)</td>
</tr>
</tbody>
</table>
Server blade components

The BL860c i2 Server Blade has SAS disk drive slots on the BL860c i2 server blade. The SAS disk drives have identical LEDs that display the drive status.
For the location of the SAS disk LEDs, see “SAS disk drive LEDs” (page 13).

SAS disk backplane

The SAS disk backplane supports two small form factor hard disk drives. The backplane supports hot-plugging a single SAS drive at a time. The activity LEDs and drive present LEDs are controlled by a preprogrammed system-on-chip. The system board hosts the SAS controller and supplies 12 V, 5 V, and 3.3 V standby power to the backplane.

The SAS backplane is connected to the system board with a right angle connector. This connector is specifically designed for high-speed differential applications, and supports server speeds exceeding 5 Gigabits per second. Power, sense, and I²C signals are routed through this connector as well as the SAS differential pairs and SGPIO signals.

I/O subsystem

The I/O subsystem is composed of embedded core I/O and up to three mezzanine cards. The server blade supports the following configurations:

- Up to three type I mezzanine cards
- One type I and up to two type II mezzanine cards using up to x8-PCIe Gen-2 links

The server blade does not support PCI Hot Plug.

Partner blade support

The partner blades currently supported are the SB40c storage blade (411243-B21) and the HP BLc PCI Expansion Blade (448018-B21).

Partner blade slotting rules are dependent on the conjoined blade configuration. For more information on partner bay blade locations, see “Installing the Scaleable BladeLink” (page 39).

Memory subsystem

The BL860c i2 physical memory subsystem connects two Itanium® processors to two groups of 12 DDR3 DIMMs. Each processor has two memory controllers.

DIMMs

The memory subsystem supports only DDR3 SDRAM technology using industry-standard 1.2” high DIMMs.

<table>
<thead>
<tr>
<th>Single DIMM sizes</th>
<th>BL860c i2 Min / Max Memory size</th>
<th>BL870c i2 Min / Max Memory size</th>
<th>BL890c i2 Min / Max Memory size</th>
</tr>
</thead>
<tbody>
<tr>
<td>2 GB</td>
<td>8 GB / 48 GB</td>
<td>Not supported</td>
<td>Not supported</td>
</tr>
<tr>
<td>4 GB</td>
<td>8 GB / 96 GB</td>
<td>16 GB / 192 GB</td>
<td>32 GB / 384 GB</td>
</tr>
<tr>
<td>8 GB</td>
<td>16 GB / 192 GB</td>
<td>32 GB / 384 GB</td>
<td>32 GB / 768 GB</td>
</tr>
</tbody>
</table>

For more DIMM information, see “Installing DIMMs” (page 26).

Power subsystem

The power subsystem is located on the system board. Each server blade receives bulk DC voltage from the enclosure. The server blade power block converts the DC voltage from the enclosure to the voltage required by the server blade. The BL860c i2 Server Blade receives 12 V directly from the enclosure. The voltage passes through E-Fuse circuitry that resides in the blade. The 12 V supply is on as long as a power supply is installed in the enclosure. A control line from the enclosure OA can turn the E-Fuse on or off to supply or cut power to the blade. The 12 V gets distributed to various POL converters. The switched POL voltage rails are: 0.9 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V, 5.0 V, 3.3 V standby, and 5.0 V standby.
Processor and supporting chipset

The BL860c i2 Server Blade contains a processor subsystem accommodating one or two Intel Itanium processor modules.

Each processor module consists of the following:
- CPU chip, including CPU cores, QPI links for CPU-CPU and CPU-IO Hub chip connections, and SMI links for CPU-Memory interface chip connections
- CPU power conversion module
- Heatsink, with mechanical attachment / assembly features

ICH mezzanine card

The ICH mezzanine card houses the following components:
- Intel ICH10 South Bridge
- ATI/AMD RN50/ES1000 Video Controller
- Embedded TPM 1.2
- The internal USB port

One ICH mezzanine card is required per system.

Scaleable BladeLink

Conjoining server blades using the Scaleable BladeLink enables four (BL870c i2) and eight (BL890c i2) socket server blade variants.

In a conjoined configuration, one of the BL860c i2 Server Blades becomes the master blade, also referred to as the monarch blade. The monarch server blade is in the lowest numbered enclosure bay, communication to the conjoined server blade is done through the monarch blade.

Each Scaleable BladeLink includes a trap door for the label carrier. To access the label carrier:
1. Locate the indentation on the upper-right corner of the access door.
2. Use the indent to pull the door open.

For more information see “Installing the Scaleable BladeLink” (page 39).

Enclosure information

All three blade configurations are supported in c7000 and c3000 Enclosures.

For more enclosure information see:
Controls, ports, and LEDs

Front panel view

1. Monarch blade indicator
2. UID LED
3. Blade health LED
4. NICs 1, 2, 3, 4
5. Monarch power button
6. HDD bay 1
7. HDD bay 2
8. Blade power LED
9. Partition Identifier
10. Physical Presence Button
11. SUV connector

⚠️ CAUTION: The SUV cable is not designed to be used as a permanent connection. Use caution when walking near the server blade when the SUV cable is installed. Hitting or bumping the cable might cause the port on the server blade to break. This can damage the system board.
### Front panel LEDs

<table>
<thead>
<tr>
<th>Item</th>
<th>Description</th>
<th>Status</th>
</tr>
</thead>
</table>
| 1    | Monarch blade indicator | Green = Blade is acting as monarch blade  
|      |              | Off = Blade is not monarch or is not conjoined |
| 2    | UID LED     | Blue = Identified  
|      |              | Blue flashing = Active remote management  
|      |              | Off = No active remote management |
| 3    | Blade health LED | Green = Normal operation  
|      |              | Amber flashing = Degraded condition  
|      |              | Red flashing = Critical condition |
| 4    | NICs 1, 2, 3, 4 | Green = Network linked  
|      |              | Green flashing = Network activity  
|      |              | Off = No link or activity |
| 5    | Monarch power button / Monarch power LED | Green = Blade is acting as monarch and is powered on  
|      |              | Amber = Blade is acting as monarch and is in standby  
|      |              | Off = Blade is not monarch |
| 6    | SUV connector | N/A |
| 7    | Physical Presence Button | N/A |
| 8    | Partition Identifier | Green = Blade is in a partition  
<p>|      |              | Off = Blade is not in a partition |</p>
<table>
<thead>
<tr>
<th>Item</th>
<th>Description</th>
<th>Status</th>
</tr>
</thead>
<tbody>
<tr>
<td>9</td>
<td>Blade power LED</td>
<td>Green = Server blade is powered on</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Amber = Standby (auxiliary power available)*</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Off = Off</td>
</tr>
<tr>
<td>Not shown</td>
<td>iLO Heartbeat</td>
<td>Green flashing = iLO Active</td>
</tr>
<tr>
<td>(behind grill)</td>
<td></td>
<td>Amber flashing = iLO failure</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Off = No standby voltage</td>
</tr>
</tbody>
</table>

*If the Onboard Administrator denies power to the server blade, the server blade returns to Standby mode.

**SAS disk drive LEDs**

There are two disk drives on the BL860c i2 Server Blade. They have identical LEDs that display the drive status.

**SAS hard drive LED combinations**

**NOTE:** Predictive failure alerts only occur when the hard drive is connected to a Smart Array controller.

<table>
<thead>
<tr>
<th>Online/activity LED (green)</th>
<th>Fault/UID LED (amber/blue)</th>
<th>Interpretation</th>
</tr>
</thead>
<tbody>
<tr>
<td>On, off, or flashing</td>
<td>Alternating amber and blue</td>
<td>The drive has failed, or a predictive failure alert has been received for this drive; it also has been selected by a management application.</td>
</tr>
<tr>
<td>On, off, or flashing</td>
<td>Steadily blue</td>
<td>The drive is operating normally, and it has been selected by a management application.</td>
</tr>
<tr>
<td>On</td>
<td>Amber, flashing regularly (1 Hz)</td>
<td>A predictive failure alert has been received for this drive. Replace the drive as soon as possible.</td>
</tr>
<tr>
<td>On</td>
<td>Off</td>
<td>The drive is online, but it is not active currently.</td>
</tr>
<tr>
<td><strong>Online/activity LED (green)</strong></td>
<td><strong>Fault/UID LED (amber/blue)</strong></td>
<td><strong>Interpretation</strong></td>
</tr>
<tr>
<td>--------------------------------</td>
<td>-------------------------------</td>
<td>--------------------</td>
</tr>
<tr>
<td>Flashing regularly (1 Hz)</td>
<td>Amber, flashing regularly (1 Hz)</td>
<td><strong>Do not remove the drive. Removing a drive might terminate the current operation and cause data loss. The drive is part of an array that is undergoing capacity expansion or stripe migration, but a predictive failure alert has been received for this drive. To minimize the risk of data loss, do not replace the drive until the expansion or migration is complete.</strong></td>
</tr>
<tr>
<td>Flashing regularly (1 Hz)</td>
<td>Off</td>
<td><strong>Do not remove the drive. Removing a drive might terminate the current operation and cause data loss. The drive is rebuilding, erasing, or it is part of an array that is undergoing capacity expansion or stripe migration.</strong></td>
</tr>
<tr>
<td>Flashing irregularly</td>
<td>Amber, flashing regularly (1 Hz)</td>
<td>The drive is active, but a predictive failure alert has been received for this drive. Replace the drive as soon as possible.</td>
</tr>
<tr>
<td>Flashing irregularly</td>
<td>Off</td>
<td>The drive is active, and it is operating normally.</td>
</tr>
<tr>
<td>Off</td>
<td>Steadily amber</td>
<td>A critical fault condition has been identified for this drive, and the controller has placed it offline. Replace the drive as soon as possible.</td>
</tr>
<tr>
<td>Off</td>
<td>Amber, flashing regularly (1 Hz)</td>
<td>A predictive failure alert has been received for this drive. Replace the drive as soon as possible.</td>
</tr>
<tr>
<td>Off</td>
<td>Off</td>
<td>The drive is offline, a spare, or not configured as part of an array.</td>
</tr>
</tbody>
</table>
## Scaleable BladeLink LEDs

<table>
<thead>
<tr>
<th>Description</th>
<th>Status</th>
</tr>
</thead>
</table>
| Busy LED     | Green  = Scaleable BladeLink is currently active. Do not remove.  
Off  = Scaleable BladeLink is not currently active. Safe to remove. |

![Diagram of Scaleable BladeLink LEDs]

Overview 15
**SUV Cable and Ports**

The SUV port on the front of the server blade is used in conjunction with an SUV cable to connect the server to external devices such as a terminal emulator or monitor.

⚠️ **CAUTION:** The SUV cable is not designed to be used as a permanent connection. Use caution when walking near the server blade when the SUV cable is installed. Hitting or bumping the cable might cause the port on the server blade to break. This can damage the system board.

---

**Rear panel view**

1. Server blade
2. Video
3. USB ports (2)
4. Serial

---

1. Power connectors
2. GBX signal connectors
Safety information

**WARNING!** Wear an ESD wrist strap when handling internal server components. Acceptable ESD wrist straps include:
- The wrist strap that is included in the ESD kit with circuit checker (part number 9300-1609).
- The wrist strap that is included in the ESD kit without circuit checker (part number 9300-1608).
- The throw away strap that ships with HP memory products.

When removing and replacing server components, use care to prevent injury and equipment damage. Many assemblies are sensitive to damage by electrostatic discharge.

Follow the safety precautions listed to ensure safe handling of components, to prevent injury, and to prevent damage to the server blade:
- When removing or installing a server blade or server blade component, review the instructions provided in this guide.
- Do not wear loose clothing that might snag or catch on the server or on other items.
- Do not wear clothing subject to static charge build-up, such as wool or synthetic materials.
- If installing an internal assembly, wear an antistatic wrist strap, and use a grounding mat such as those included in the Electrically Conductive Field Service Grounding Kit.
- Handle components by the edges only. Do not touch any metal-edge connectors or electrical components on accessory boards.

### Installation sequence and checklist

<table>
<thead>
<tr>
<th>Step</th>
<th>Description</th>
<th>Completed</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Unpack and inspect the server shipping container and then inventory the contents using the packing slip.</td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>Install additional components shipped with the server.</td>
<td></td>
</tr>
<tr>
<td>3</td>
<td>Install and power on the server blade.</td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>Configure iLO MP access.</td>
<td></td>
</tr>
<tr>
<td>5</td>
<td>Access iLO MP.</td>
<td></td>
</tr>
<tr>
<td>6</td>
<td>Access UEFI from iLO MP.</td>
<td></td>
</tr>
<tr>
<td>7</td>
<td>Download latest firmware using HP Smart Update Manager</td>
<td></td>
</tr>
<tr>
<td>8</td>
<td>Install and boot the OS.</td>
<td></td>
</tr>
</tbody>
</table>

### Unpacking and inspecting the server blade

Ensure that you have adequately prepared your environment for your new server, received the components that you ordered, and verified that the server and its containers are in good condition after shipment.

### Verify site preparation

Verifying site preparation is an essential factor of a successful server blade installation, and includes the following tasks:
- Gather LAN information. Determine the two IP addresses for the iLO 3 MP LAN and the server blade LAN.
- Establish a method to connect to the server blade console. For more information on console connection methods, see Section: “Using iLO” (page 41) for more information.
• Verify electrical requirements. Ensure that grounding specifications and power requirements are met.
• Confirm environmental requirements.

Inspect the shipping containers for damage
HP shipping containers protect their contents under normal shipping conditions. After the equipment arrives, carefully inspect each carton for signs of shipping damage. Shipping damage constitutes moderate to severe damage, such as punctures in the corrugated carton, crushed boxes, or large dents. Normal wear or slight damage to the carton is not considered shipping damage. If you find shipping damage to the carton, contact your HP customer service representative immediately.

Unpack the server blade
1. Use the instructions printed on the outside top flap of the carton.
2. Remove inner accessory cartons and the top foam cushions.

IMPORTANT: Inspect each carton for shipping damage as you unpack the server blade.
3. Place the server blade on an antistatic pad.

Check the inventory
The sales order packing slip lists the equipment shipped from HP. Use this packing slip to verify that the equipment has arrived.

NOTE: To identify each item by part number, see the sales order packing slip.

Damaged equipment returns
If the equipment is damaged, immediately contact your HP customer service representative. The service representative initiates appropriate action through the transport carrier or the factory and assists you in returning the equipment.

Installing additional components
If your server blade has no additional components to install, go to “Installing and powering on the server blade” (page 32).
Installing a hot-plug SAS disk drive

The server blade supports up to two hot-plug SAS drives.

⚠️ CAUTION: To prevent improper cooling and thermal damage, do not operate the server blade or the enclosure unless all hard drive and device bays are populated with either a component or a blank.

📝 IMPORTANT: The disk drive will not seat properly when 180 degrees out of alignment. Check the orientation before insertion.

📝 NOTE: For a list of supported disk drives for the server blade, see: http://h18004.www1.hp.com/products/blades/components/c-class-storage.html

1. Remove the hard drive blank.

2. Prepare the hard drive.

3. Slide the drive into the cage until it is fully seated.
4. Close the lever to lock the drive into place.

Installing internal components

Removing the access panel

1. Unlock the cam on the access panel latch (if necessary) by turning the lock on the access panel latch counter-clockwise with a Torx T-15 or flathead screwdriver.
2. Pull up on the access panel latch. This causes the access panel to slide back about 2 cm (0.75 in).
3. Remove the access panel by lifting it straight up and off the server blade.

After the access panel is off, you can do the following:

- Add an additional processor (“Installing a processor and heatsink module”).
- Add additional memory DIMMs (“Installing DIMMs”).
- Add additional mezzanine cards (“Installing mezzanine cards”).
Installing a processor and heatsink module

Processor load order

Observe the following guidelines when installing additional processors:
• In a BL860c i2, CPU0 is installed before CPU1.
• In a BL870 i2 or BL890 i2, each blade must have CPU0 installed.
• When adding additional CPUs in a conjoined configuration:
  — Load both CPU0 and CPU1 in the monarch blade first
  — Load additional CPUs in sequence, from lowest slot-numbered blade to highest.

⚠️ **CAUTION:** The pins on the processor socket are very fragile. Any damage to them may require replacing the server blade base unit.

⚠️ **CAUTION:** To avoid damage to the processor, verify that the plastic tabs on the processor are pulled fully out before installation.

⚠️ **CAUTION:** To avoid damage to the processor, handle the processor only by the edges. Do not touch the bottom of the processor, especially the contact area.

⚠️ **CAUTION:** To prevent possible server blade malfunction and damage to the equipment, multiprocessor configurations must contain processors with the same part number.

⚠️ **CAUTION:** To prevent thermal instability and damage to the server, do not separate the processor from the heatsink after assembling.

The processor and heatsink ship as two separate units and are coupled together during installation into the server blade.

1. Remove the CPU airflow baffle.
2. Transfer the duplicate part/serial numbers label from the processor module to the processor’s heatsink.
   a. Remove the duplicate yellow tear-away label that lists the part and serial numbers from the processor module.
   b. Place the label on the top of the heatsink.

3. Install the processor over the load posts.

   **NOTE:** Ensure pin 1, indicated on the empty socket with an embossed triangle, matches the pin 1 marker on the processor module, the chamfered corner of its attached voltage regulator heatsink.

4. Remove the heatsink cover.
CAUTION: During installation, after removing the protective cover from the heatsink:

- Do not touch or come into contact with the thermal interface material.
- Immediately install the heatsink.
CAUTION: To avoid damage to the server blade and processor, ensure the processor heatsink’s locking handle is fully back against the stops, rotated about 120° back. Also verify that the plastic tabs on the processor's heatsink are pulled fully out before installation.

5. Install the heatsink over the load posts.

CAUTION: Do not lower the heatsink locking handle before pushing the plastic locking tabs into place.

CAUTION: To prevent thermal instability and damage to the server blade, do not separate the processor module from the processor’s heatsink after they have been coupled.

NOTE: Positive engagement clicking should occur during mating of the processor heat sink and processor module onto the socket to ensure proper seating.
6. Secure the heatsink to the processor
   a. Slide both plastic locking tabs into place (see callout 1 in the image below).
   b. Flip the latch down (see callout 2 in the image below).

⚠️ **WARNING!** The heatsink locking lever can constitute a pinch hazard, keep your hands on top of the lever during installation to avoid personal injury.

⚠️ **CAUTION:** To prevent thermal instability and damage to the server, do not separate the processor module from the processor’s heatsink after they have been coupled.

7. Connect the power cord (see callout 3 in the image above).
8. Tie wrap the processor cable to the right tie point on the processor assembly.

⚠️ **CAUTION:** When the CPU is installed, dress all slack in the power cable to the connector end of the cable. Failure to do so could result in pinched or damaged CPU power cables.

>Note: If you are adding an additional processor to your server blade, the DIMMs in the server blade must be reconfigured to support both CPUs. See “DIMM pair load order” (page 27) for more information.

---

**Installing DIMMs**

**DIMM installation guidelines**

Observe the following guidelines when installing additional memory:

- In a BL860c i2, memory is loaded in pairs.
- In a BL870 i2 or BL890 i2, memory is loaded in quads that alternate between blades.
- Only 2 DIMM sizes can be mixed in a BL870 i2 or BL890 i2.
  - In a BL870c i2, the two DIMM sizes must alternate between blades. Load all of one DIMM size, then repeat with the second DIMM size.
  - In a BL890c i2, blade configuration, blades 1 and 2 must have one DIMM size and blades 3 and 4 must have the other DIMM size.
DIMM pair load order

Table 1-1 DIMM pair load order

<table>
<thead>
<tr>
<th></th>
<th>CPU0</th>
<th>CPU1</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>CPU0 only</strong></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1st</td>
<td>3A</td>
<td>4A</td>
</tr>
<tr>
<td>2nd</td>
<td>9B</td>
<td>10B</td>
</tr>
<tr>
<td>3rd</td>
<td>1C</td>
<td>6C</td>
</tr>
<tr>
<td>4th</td>
<td>7D</td>
<td>12D</td>
</tr>
<tr>
<td>5th</td>
<td>2E</td>
<td>5E</td>
</tr>
<tr>
<td>6th</td>
<td>8F</td>
<td>11F</td>
</tr>
<tr>
<td><strong>Both CPUs loaded</strong></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1st</td>
<td>3A</td>
<td>4A</td>
</tr>
<tr>
<td>2nd</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>3rd</td>
<td>9B</td>
<td>10B</td>
</tr>
<tr>
<td>4th</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>5th</td>
<td>1C</td>
<td>6C</td>
</tr>
<tr>
<td>6th</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>7th</td>
<td>7D</td>
<td>12D</td>
</tr>
<tr>
<td>8th</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>9th</td>
<td>2E</td>
<td>5E</td>
</tr>
<tr>
<td>10th</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>11th</td>
<td>8F</td>
<td>11F</td>
</tr>
<tr>
<td>12th</td>
<td>—</td>
<td>—</td>
</tr>
</tbody>
</table>
### DIMM quad load order rules

#### Table 1-2 DIMM quad load order

<table>
<thead>
<tr>
<th>Both CPUs loaded</th>
<th>CPU0</th>
<th>CPU1</th>
</tr>
</thead>
<tbody>
<tr>
<td>1st</td>
<td>3A</td>
<td>4A</td>
</tr>
<tr>
<td>2nd</td>
<td>9B</td>
<td>10B</td>
</tr>
<tr>
<td>3rd</td>
<td>1A</td>
<td>7A</td>
</tr>
<tr>
<td>4th</td>
<td>1C</td>
<td>6C</td>
</tr>
<tr>
<td>5th</td>
<td>5D</td>
<td>12D</td>
</tr>
<tr>
<td>6th</td>
<td>2E</td>
<td>8E</td>
</tr>
</tbody>
</table>

Both CPUs loaded:
- 1st: 3A, 4A, 9B, 10B
- 2nd: 1A, 7A, 6B, 10B
- 3rd: 1C, 6C, 7D, 12D
- 4th: 3C, 9C, 4D, 12D
- 5th: 2E, 5E, 8F, 11F
- 6th: 2E, 8E, 5F, 11F

Installing the server blade into the enclosure
To install the DIMMs:

1. Remove the DIMM baffle.

2. Locate the DIMM slots on the server blade system board.
3. Ensure the DIMM slot latches are open.

**CAUTION:** Use only HP low profile (1.2 in.) DIMMs. DIMMs from other sources might adversely affect data integrity. DIMMs do not seat fully if turned the wrong way. DIMMs in a pair or quad must be identical.

4. Insert a DIMM in a slot and push down firmly until the latches click shut.

---

**Installing mezzanine cards**

Optional mezzanine cards enable additional network connectivity and provide Fibre Channel support. For mezzanine card locations, see “Server blade components” (page 8). Optional mezzanine cards are classified as Type I mezzanine cards and Type II mezzanine cards. The card type determines where it can be installed in the server blade:

- Install Type I mezzanine cards on any mezzanine connector.
- Install Type II mezzanine cards only on Mezzanine 2 connector or Mezzanine 3 connector.

To install a card:
1. Remove the mezzanine connector cover.

2. Align the mezzanine connector on the option card with the mezzanine connector on the system board.
3. Install the mezzanine card. Press down on the connector to seat the card:

**CAUTION:** To prevent damage to the server blade, apply pressure over the mezzanine connector when installing the mezzanine card. Do not apply pressure to the edges of the card.

**NOTE:** The HP Smart Array P700m Controller requires additional procedures for installation. Refer to the *HP Integrity BL860c i2, BL870c i2 & BL890c i2 Server Blade User Service Guide* for more information.

Replacing the access panel

1. Make sure the access panel latch is in the open position (pointing up).
2. Place the access panel onto the server blade by lining up the posts on each side of the access panel with the keyways on the server blade chassis.

3. Slide the access panel toward the front of the server blade, and push down on the access panel latch until it is flush with the access panel.

4. Lock the access panel cam (if necessary) by turning the cam clockwise with the Torx T–15 or flathead screwdriver.

Installing and powering on the server blade

Preparing the enclosure

HP BladeSystem enclosures ship with device bay dividers to support half-height devices. To install a full height device, remove the blanks and the corresponding device bay divider.

⚠️ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server blade or the enclosure unless all hard drive and device bays are populated with either a component or a blank.

1. Remove the device bay blank.

2. Remove the three adjacent blanks.
Removing a c7000 device bay divider

1. Slide the device bay shelf locking tab to the left to open it.

2. Push the device bay shelf back until it stops, lift the right side slightly to disengage the two tabs from the divider wall, and then rotate the right edge downward (clockwise).
3. Lift the left side of the device bay shelf to disengage the three tabs from the divider wall, and then remove it from the enclosure.

Removing a c3000 device bay mini-divider or device bay divider

1. Slide the locking tab down.
2. Remove the mini-divider or divider:
   • c3000 mini-divider:
     Push the divider toward the back of the enclosure until the divider drops out of the enclosure.
   • c3000 divider
     a. Push the divider toward the back of the enclosure until it stops.
     b. Slide the divider to the left to disengage the tabs from the wall.
     c. Rotate the divider clockwise.
     d. Remove the divider from the enclosure.

Installing interconnect modules
For specific steps to install interconnect modules, see the documentation that ships with the interconnect module.
Interconnect bay numbering and device mapping

- HP BladeSystem c7000 Enclosure

To support network connections for specific signals, install an interconnect module in the bay corresponding to the embedded NIC or mezzanine signals.

<table>
<thead>
<tr>
<th>Server blade signal</th>
<th>c7000 interconnect bay</th>
<th>c3000 interconnect bay</th>
<th>Interconnect bay labels</th>
</tr>
</thead>
<tbody>
<tr>
<td>NIC 1 (Embedded)</td>
<td>1</td>
<td>1</td>
<td></td>
</tr>
<tr>
<td>NIC 2 (Embedded)</td>
<td>2</td>
<td>1</td>
<td></td>
</tr>
<tr>
<td>NIC 3 (Embedded)</td>
<td>1</td>
<td>1</td>
<td></td>
</tr>
<tr>
<td>NIC 4 (Embedded)</td>
<td>2</td>
<td>1</td>
<td></td>
</tr>
<tr>
<td>Mezzanine 1</td>
<td>3 and 4</td>
<td>2</td>
<td></td>
</tr>
</tbody>
</table>
### Interconnect Bay Labels

<table>
<thead>
<tr>
<th>Server Blade Signal</th>
<th>c7000 Interconnect Bay</th>
<th>c3000 Interconnect Bay</th>
<th>Interconnect Bay Labels</th>
</tr>
</thead>
<tbody>
<tr>
<td>Mezzanine 2</td>
<td>5 and 6</td>
<td>3 and 4</td>
<td>🟢</td>
</tr>
<tr>
<td></td>
<td>7 and 8</td>
<td>3 and 4</td>
<td>🟦</td>
</tr>
<tr>
<td>Mezzanine 3</td>
<td>5 and 6</td>
<td>3 and 4</td>
<td>🟢</td>
</tr>
<tr>
<td></td>
<td>7 and 8</td>
<td>3 and 4</td>
<td>🟦</td>
</tr>
</tbody>
</table>

For detailed port mapping information, see the HP BladeSystem enclosure installation poster or the HP BladeSystem enclosure setup and installation guide for your product on the HP website (http://www.hp.com/go/bladesystem/documentation).

## Installing the Server Blade into the Enclosure

**NOTE:** When installing additional blades into an enclosure, additional power supplies might also be needed to meet power requirements. For more information, see the HP BladeSystem enclosure setup and installation guide for your product on the HP website (http://www.hp.com/go/bladesystem/documentation).

**NOTE:** Before installing and initializing the server blade, install any server blade options, such as an additional processor, hard drive, or mezzanine card.

**NOTE:** Refer to the *HP Integrity BL860c i2, BL870c i2 & BL890c i2 User Service Guide* for information regarding SAS controller configuration.

1. Remove the connector covers if they are present.

![Image of connector covers being removed](image)

2. Prepare the server blade for installation.
3. Install the server blade.

The server blade should come up to standby power. The server blade is at standby power if the blade power LED is amber.
**NOTE:** Before installing the Scaleable BladeLink for BL870c or BL890c, make sure the following statements are true:

- All blades have the same CPU SKUs.
- All blades have the same hardware revision
- All blades have CPU0 installed.
- All blades follow the memory loading rules for your configuration, see “Installing DIMMs” (page 26).
- The enclosure OA firmware is compatible with the blade firmware.
- The monarch blade has an ICH mezzanine card installed.

### Scaleable BladeLink bay location rules

<table>
<thead>
<tr>
<th>Class</th>
<th>Scaleable BladeLink part number</th>
<th>Number of conjoined blades</th>
<th>Supported enclosures</th>
<th>Blade location rules</th>
<th>Partner blade support?</th>
<th>Partner blade bay location rules in half-height blade device bays</th>
</tr>
</thead>
<tbody>
<tr>
<td>SBL1</td>
<td>AD399-60002</td>
<td>1 (standard for BL860c i2)</td>
<td>c7000</td>
<td>No specific bay location rules for blades</td>
<td>Yes</td>
<td>Right bottom or left bottom half-height adjacent bay paired with the server blade in full-height bays 1&amp;2, 3&amp;4, 5&amp;6, or 7&amp;8.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Top right or bottom right half-height adjacent bay paired with the server blade in full-height bays 1&amp;2 or 3&amp;4.</td>
</tr>
<tr>
<td>SBL2</td>
<td>AD399-60003</td>
<td>2 (BL870c i2)</td>
<td>c7000</td>
<td>Bays 1&amp;2, 3&amp;4, 5&amp;6, or 7&amp;8 with monarch blade in odd bay</td>
<td>No</td>
<td>N/A</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Bays 1&amp;2, 3&amp;4 with monarch blade in odd bay</td>
</tr>
<tr>
<td>SBL2E</td>
<td>AD399-60010</td>
<td>2 (BL870c i2)</td>
<td>c7000 only</td>
<td>Bays 2&amp;3, 4&amp;5 or 6&amp;7 with monarch blade in even bay</td>
<td>Yes</td>
<td>Odd bottom half-height bay adjacent to monarch blade.</td>
</tr>
<tr>
<td>AD399-60011</td>
<td>2 (BL870c i2)</td>
<td>c3000 only</td>
<td>Bays 2&amp;3 with monarch blade in even bay</td>
<td>Yes</td>
<td>Top right or bottom right half-height adjacent bay.</td>
<td></td>
</tr>
</tbody>
</table>
To install the Scaleable BladeLink:

1. Log on to the OA.
2. Install the first blade into the lowest bay number, this blade becomes the monarch blade (“Installing the server blade into the enclosure”).
3. Wait 10 seconds. The IP address of the installed blade will appear in the OA.
4. Insert each adjacent blade, waiting 10 seconds between blades.
5. Using the OA, verify that the rest of the blades that will be conjoined have an IP address and are powered off.
6. Remove the plastic protectors from the connectors on the back of the Scaleable BladeLink.
7. Push in the blue release latch on the handle to release the handle.
8. Pull the handle all the way out
9. Align the guide pins on the back of the Scaleable BladeLink to the holes on the front of the server blades.
10. Fully insert the Scaleable BladeLink into the blades, and then close the handle.
11. Log into iLO on the monarch blade. For more information, see the *HP Integrity iLO3 Operations Guide*.
12. In iLO, go to the Command Menu and execute `xd -r` to reboot iLOs in the conjoined set.
13. Still in the iLO Command Menu, power on the monarch blade with the `PC -on -nc` command. Powering on the monarch blade will power the entire conjoined system on.
14. Boot the monarch blade. Booting the monarch blade boots the entire conjoined system.
Server blade power states

The server blade has three power states: standby power, full power, and off. Install the server blade into the enclosure to achieve the standby power state. Server blades are set to power on to standby power when installed in a server blade enclosure. Verify the power state by viewing the LEDs on the front panel, and using Table 1-3.

For more front panel LED information, see “Front panel LEDs” (page 12).

**Table 1-3 Power States**

<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>Standby power</td>
<td>Yes</td>
<td>No</td>
<td>Yes</td>
<td>No</td>
</tr>
<tr>
<td>Full power</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
</tr>
<tr>
<td>Off</td>
<td>No</td>
<td>No</td>
<td>No</td>
<td>No</td>
</tr>
</tbody>
</table>

**Powering on the server blade**

Use one of the following methods to power up the server blade:

**NOTE:** To power on blades in a conjoined configuration, only power on the monarch blade.

- Use a virtual power button selection through iLO.
- Press and release the monarch power button.

When the server blade goes from the standby mode to the full power mode, the blade power LED changes from amber to green.

For more information about iLO, see “Using iLO” (page 41).

**Powering off the server blade**

Before powering down the server blade for any upgrade or maintenance procedures, perform a backup of critical server data and programs.

Use one of the following methods to power down the server blade:

**NOTE:** To power off blades in a conjoined configuration, only power off the monarch blade.

- Use a virtual power button selection through iLO (Power Management, Power & Reset). This method initiates a controlled remote shutdown of applications and the OS before the server blade enter standby mode.
- Press and release the monarch power button. This method initiates a controlled shutdown of applications and the OS before the server blade enter standby mode.
- Press and hold the monarch power button for more than 4 seconds to force the server blade to enter standby mode.

This method forces the server blade to enter standby mode without properly exiting applications and the OS. It provides an emergency shutdown method in the event of a hung application.

**Using iLO**

The iLO subsystem is a standard component of selected server blades that provides blade health and remote server manageability. The iLO subsystem includes an intelligent microprocessor, secure memory, and a dedicated network interface. This design makes iLO independent of the
host server and operating system. The iLO subsystem provides remote access to any authorized network client, sends alerts, and provides other server management functions.

Using iLO, you can:

- Remotely power up, power down, or reboot the host server.
- Send alerts from iLO regardless of the state of the host server.
- Access advanced troubleshooting features through the iLO interface.
- Diagnose iLO using HP SIM through a web browser and SNMP alerting.

For more information about iLO basic features, refer to the iLO documentation on the HP website (http://www.hp.com/servers/lights-out).

Accessing UEFI or the OS from iLO MP

The Unified Extensible Firmware Interface is an architecture that provides an interface between the server blade OS and the server blade firmware. UEFI provides a standard environment for booting an OS and running preboot applications.

Use this procedure to access UEFI or the OS from the iLO MP. Your security parameters were set regarding remote access.

- From the **MP Main Menu**, enter `co` to access the **Console**.

**NOTE:** Terminal windows should be set to a window size of 80 columns x 25 rows for optimal viewing of the console at UEFI.

Depending on how the server blade was configured from the factory, and if the OS is installed at the time of purchase, you are taken to:

- UEFI shell prompt
- OS login prompt

If the server blade has a factory-installed OS, you can interrupt the boot process to configure your specific UEFI parameters.

If you are at the UEFI shell prompt, go to “UEFI Front Page” (page 42).

If you are at the OS login prompt, go to “OS login prompt” (page 44).

**UEFI Front Page**

If you are at the UEFI shell prompt, enter `exit` to get to the **UEFI Front Page**.
To view boot options, or launch a specific boot option, press B or b to launch the Boot Manager.

To configure specific devices, press D or d to launch the Device Manager. This is an advanced feature and should only be performed when directed.
To perform maintenance on the system such as adding, deleting, or reordering boot options, press M or m to launch the Boot Maintenance Manager.

To perform more advanced operations, press S or s to launch the UEFI Shell.
To view the iLO LAN configuration, press I or i to launch the iLO Setup Tool.

Saving UEFI configuration settings
There are other UEFI settings you can configure at this time. For more UEFI configuration options, see the HP Integrity BL860c i2, BL870c i2 & BL890c i2 Server Blade User Service Guide.

Booting and installing the operating system

From the UEFI Front Page prompt, you can boot and install in either of two manners:

- If your OS is loaded onto your server blade, see “Operating system is loaded onto the server blade” (page 44).
- If the OS is not installed onto your server blade, see “Operating system is not loaded onto the server blade” (page 44).

Operating system is loaded onto the server blade

If the OS is loaded on your server blade, normally UEFI will automatically boot to the OS. If the UEFI Front Page is loaded, press ENTER to start auto boot, or B or b to select a specific boot option for your OS.

- Use your standard OS logon procedures, or see your OS documentation to log on to your OS.

Operating system is not loaded onto the server blade

See the HP Integrity BL860c i2, BL870c i2 & BL890c i2 User Service Guide for instructions on loading an operating system onto a server blade.

OS login prompt

If your server blade is at the OS login prompt after you establish a connection to the server blade, use your standard OS log in procedures, or see your OS documentation for the next steps.
Installing the latest firmware using HP Smart Update Manager

The HP Smart Update Manager utility enables you to deploy firmware components from either an easy-to-use interface or a command line. It has an integrated hardware discovery engine that discovers the installed hardware and the current versions of firmware in use on target servers. This prevents extraneous network traffic by only sending the required components to the target. HP Smart Update Manager also has logic to install updates in the correct order and ensure all dependencies are met before deployment of a firmware update. It also contains logic to prevent version-based dependencies from destroying an installation and ensures updates are handled in a manner that reduces any downtime required for the update process. HP Smart Update Manager does not require an agent for remote installations. After the installation is complete, HP Smart Update Manager also cleans up after itself.

Key features of HP Smart Update Manager are:
- GUI and CLI—command line interface.
- Dependency checking, which ensures appropriate installation order and dependency checking between components.
- Intelligent deployment deploys only required updates.
- Improved deployment performance.
- Remote command-line deployment.
- Can install firmware for BL860c i2, BL870c i2, and BL890c i2 from Windows X86 or Linux X86
- Support for updating up to 29 target servers simultaneously.

HP Smart Update Manager is included in the firmware bundles downloaded from hp.com and is supported on manage / update FW for the BL860c i2, BL870c i2, and BL890c i2 from X86 Windows or X86 Linux.

For more information about HP Smart Update Manager, see the HP Smart Update Manager User Guide (www.hp.com/support/HP_Smart_Update_Manager_UG_en).
2 Support and other resources

Contacting HP

Before you contact HP

Be sure to have the following information available before you call contact HP:

- Technical support registration number (if applicable)
- Product serial number
- Product model name and number
- Product identification number
- Applicable error message
- Add-on boards or hardware
- Third-party hardware or software
- Operating system type and revision level

HP contact information

For the name of the nearest HP authorized reseller:

- In the United States, see the HP US service locator webpage (http://welcome.hp.com/country/us/en/wwcontact.html).
- In other locations, see the Contact HP worldwide (in English) webpage: http://welcome.hp.com/country/us/en/wwcontact.html.

For HP technical support:

- In the United States, for contact options see the Contact HP United States webpage: (http://welcome.hp.com/country/us/en/contact_us.html)
  To contact HP by phone:
  — Call 1-800-HP-INVENT (1-800-474-6836). This service is available 24 hours a day, 7 days a week. For continuous quality improvement, calls may be recorded or monitored.
  — If you have purchased a Care Pack (service upgrade), call 1-800-633-3600. For more information about Care Packs, refer to the HP website: (http://www.hp.com/hps).
- In other locations, see the Contact HP worldwide (in English) webpage (http://welcome.hp.com/country/us/en/wwcontact.html)

Subscription service


Documentation feedback

HP welcomes your feedback. To make comments and suggestions about product documentation, send a message to docsfeedback@hp.com.

Include the document title and manufacturing part number. All submissions become the property of HP.

Typographic conventions

This document uses the following typographical conventions:
A percent sign represents the C shell system prompt. A dollar sign represents the system prompt for the Bourne, Korn, and POSIX shells. A number sign represents the superuser prompt.

`audit(5)`
A manpage. The manpage name is `audit`, and it is located in Section 5.

**Command**
A command name or qualified command phrase.

**Computer output**
Text displayed by the computer.

**Ctrl+x**
A key sequence. A sequence such as `Ctrl+x` indicates that you must hold down the key labeled `Ctrl` while you press another key or mouse button.

**ENVIRONMENT VARIABLE**
The name of an environment variable, for example, `PATH`.

**[ERROR NAME]**
The name of an error, usually returned in the `errno` variable.

**Key**
The name of a keyboard key. `Return` and `Enter` both refer to the same key.

**Term**
The defined use of an important word or phrase.

**User input**
Commands and other text that you type.

**Variable**
The name of a placeholder in a command, function, or other syntax display that you replace with an actual value.

**[]**
The contents are optional in syntax. If the contents are a list separated by `,`, you must choose one of the items.

**[]**
The contents are required in syntax. If the contents are a list separated by `,`, you must choose one of the items.

**...**
The preceding element can be repeated an arbitrary number of times.

**∅**
Indicates the continuation of a code example.

**|**
Separates items in a list of choices.

**WARNING**
A warning calls attention to important information that if not understood or followed will result in personal injury or nonrecoverable system problems.

**CAUTION**
A caution calls attention to important information that if not understood or followed will result in data loss, data corruption, or damage to hardware or software.

**IMPORTANT**
This alert provides essential information to explain a concept or to complete a task.

**NOTE**
A note contains additional information to emphasize or supplement important points of the main text.
<table>
<thead>
<tr>
<th>Letter</th>
<th>Acronym</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>C</td>
<td>CLI</td>
<td>Command line interface</td>
</tr>
</tbody>
</table>
| E      | EFI     | Extensible Firmware Interface  
|        |         | *See also UEFI.* |
| E      | ESD     | Electrostatic discharge |
| I      | iLO     | Integrated Lights-Out |
| M      | MP      | Management processor |
| O      | OA      | Onboard Administrator |
| P      | PCI     | Peripheral component interface |
|       | PCIe    | Peripheral component interconnect express |
| Q      | QPI     | Intel QuickPath Interconnect |
| S      | SAS     | Serial attached SCSI |
|        | SATA    | Serial ATA |
|        | SIM     | System insight manager |
|        | SNMP    | Simple Network Management Protocol |
| T      | TPM     | Trusted platform module |
| U      | UEFI    | Unified Extensible Firmware Interface, replaces EFI. |
| U      | UID     | Unit identification |
| U      | USB     | Universal serial bus |
Index

A
access panel
   replacing, 31
antistatic wrist strap, 17

C
c-Class enclosure (see enclosure)
   checking the inventory, 18
   component locations, 8
   confirming the packing slip, 18

D
damaged equipment, 18
   dimensions of server blade, 7
DIMMs
   overview, 9
   slot locations, 30
disk drive backplane (see SAS backplane)

E
   enclosure, 10

F
   firmware
      updates, 45
      front panel
         LEDs, 12
         port, 11

H
   HDD backplane (see SAS backplane)
   HP Smart Update Manager, 45
   HP-UX Ignite, 44
   HPSUM (see HP Smart Update Manager)

I
   I/O subsystem
      overview, 9
   iLO MP
      accessing UEFI from, 42
      inspecting the shipping container, 18
      installing
         processor, 21
         SAS disk drives, 19
         Scaleable BladeLink, 39
   server blade
      access panel, 20
      components, 8
      dimensions, 7
      front view, 11
      LEDs, 13
      overview, 7
      powering off, 41
      powering on, 41
      rear panel connectors, 16
      rear view, 16
      returning a damaged server blade, 18
      unpacking, 18
      weight, 7
   shipping damage, 18
   site preparation, 17
   slot locations
      SAS disk drives, 8
      SUV cable, 16
      SUV cable port, 11
specifications, 9
   ports
      front panel, 11
      rear panel, 16
   power button, 41
   power subsystem
      specifications, 9
   powering off, server blade, 41
   powering on
      default, automatically, 41
      server blade, 41
   processor
      installing, 21
      overview, 10
   Processor and supporting chipset
      overview, 10

R
   rear panel
      ports, 16
   removing
      access panel, 20
   replacing
      access panel, 31
   returning a damaged server blade, 18

S
   safety information, 17
   SAS backplane
      overview, 9
   SAS disk drives
      LEDs, 13
      slot locations, 8
   Scaleable BladeLink
      installing, 39
   server blade
      access panel, 20, 31
      components, 8
      dimensions, 7
      front panel, 11
      LEDs, 12
      power button, 41
      power subsystem
         specifications, 9
      powering off, server blade, 41
      powering on
         default, automatically, 41
         server blade, 41
      processor
         installing, 21
         overview, 10
   Processor and supporting chipset
      overview, 10

specifications, 9
   ports
      front panel, 11
      rear panel, 16
   power button, 41
   power subsystem
      specifications, 9
   powering off, server blade, 41
   powering on
      default, automatically, 41
      server blade, 41
   processor
      installing, 21
      overview, 10
   Processor and supporting chipset
      overview, 10
   shipping damage, 18
   site preparation, 17
   slot locations
      SAS disk drives, 8
      SUV cable, 16
      SUV cable port, 11

   specifications, 9
   ports
      front panel, 11
      rear panel, 16
   power button, 41
   power subsystem
      specifications, 9
   powering off, server blade, 41
   powering on
      default, automatically, 41
      server blade, 41
   processor
      installing, 21
      overview, 10
   Processor and supporting chipset
      overview, 10
   shipping damage, 18
   site preparation, 17
   slot locations
      SAS disk drives, 8
      SUV cable, 16
      SUV cable port, 11
U
UEFI
  accessing from iLO MP, 42
  saving configuration settings, 44
unpacking the server blade, 18

V
virtual power button, 41

W
weight of server blade, 7
wrist strap, antistatic, 17